



Docket No.: 49657-986

#6/Amatc  
3.17.03  
C. Moore  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Takao KAMOSHIMA, et al.

Serial No.: 09/779,565

Group Art Unit: 2814

Filed: February 09, 2001

Examiner: T. Le

For: SEMICONDUCTOR DEVICE WITH INTERCONNECTION LAYER

AMENDMENT

Commissioner for Patents  
Washington, DC 20231

Sir:

The following Amendment and Remarks are submitted in response to the Office Action dated December 11, 2002.

**IN THE TITLE:**

Please delete the title and insert --SEMICONDUCTOR DEVICE WITH  
INTERCONNECTION LAYER--.

**IN THE CLAIMS:**

Please amend claim 1 as follows.

1. (Amended) A semiconductor device, comprising:  
a semiconductor substrate; and

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